Rectifier diodes schottky barrier

PBYR3045PTF series

GENERAL DESCRIPTION

Dual, low leakage, platinum barrier, schottky barrier rectifier diodes in a full pack, plastic envelope featuring low forward voltage drop and absence of stored charge. These devices can withstand reverse voltage transients and have guaranteed reverse surge capability. The devices are intended for use in switched mode power supplies and high frequency circuits in general where low conduction and zero switching losses are important.

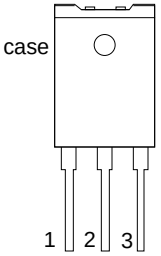
QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	MAX.	MAX.	UNIT
	PBYR30-	**35CTF**	**40CTF**	**45CTF**	
V_{RRM}	Repetitive peak reverse voltage	35	40	45	V
V_F	Forward voltage	0.65	0.65	0.65	V
$I_{O(AV)}$	Output current (both diodes conducting)	20	20	20	A

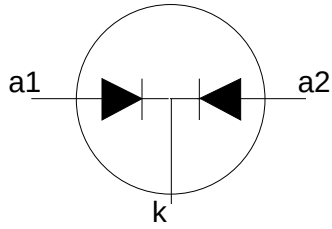
PINNING - SOT199

PIN	DESCRIPTION
1	anode 1 (a)
2	cathode (k)
3	anode 2 (a)

PIN CONFIGURATION



SYMBOL



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.			UNIT
				-35	**-40**	**-45**	
V_{RRM}	Repetitive peak reverse voltage		-	35	40	45	V
V_{RWM}	Crest working reverse voltage		-	35	40	45	V
V_R	Continuous reverse voltage	$T_{hs} \leq 113$ ˚C	-	35	40	45	V
$I_{O(AV)}$	Output current (both diodes conducting)	square wave; $\delta = 0.5$; $T_{hs} \leq 109$ ˚C	-	20			A
$I_{O(RMS)}$	RMS forward current		-	20			A
I_{FRM}	Repetitive peak forward current per diode	t = 25 µs; $\delta = 0.5$; $T_{hs} \leq 109$ ˚C	-	30			A
I_{FSM}	Non-repetitive peak forward current per diode.	t = 10 ms	-	135			A
		t = 8.3 ms sinusoidal; $T_j = 125$ ˚C prior to surge; with reapplied $V_{RWM(max)}$	-	150			A
I^2t	I^2t for fusing	t = 10 ms	-	91			A^2s
I_{RRM}	Repetitive peak reverse current per diode.	$t_p = 2$ µs; $\delta = 0.001$	-	2			A
I_{RSM}	Non-repetitive peak reverse current per diode.	$t_p = 100$ µs	-	2			A
T_{stg}	Storage temperature		-65	175			˚C
T_j	Operating junction temperature		-	150			˚C

ISOLATION

T_{hs} = 25 ˚C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_{isol}	Repetitive peak voltage from all three terminals to external heatsink	R.H. ≤ 65 % ; clean and dustfree	-	-	2500	V
C_{isol}	Capacitance from T2 to external heatsink	f = 1 MHz	-	22	-	pF

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$R_{th\ j\text{-}hs}$	Thermal resistance junction to heatsink	per diode	-	-	4.0	K/W
		both diodes (with heatsink compound)	-	-	3.5	K/W
$R_{th\ j\text{-}a}$	Thermal resistance junction to ambient	in free air.	-	35	-	K/W

STATIC CHARACTERISTICS

T_j = 25 ˚C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_F	Forward voltage (per diode)	I_F = 30 A; T_j = 125˚C	-	0.70	0.75	V
		I_F = 20 A; T_j = 125˚C	-	0.58	0.65	V
		I_F = 30 A	-	0.75	0.80	V
I_R	Reverse current (per diode)	$V_R = V_{RWM}$	-	100	200	µA
		$V_R = V_{RWM}$; T_j = 125 ˚C	-	12	40	mA
C_d	Junction capacitance (per diode)	f = 1MHz; V_R = 5V; T_j = 25 ˚C to 125 ˚C	-	800	-	pF

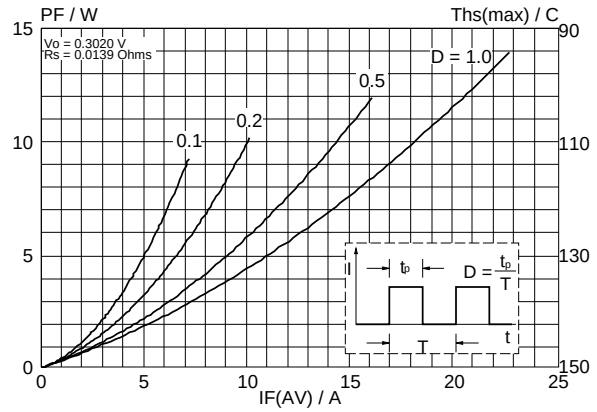


Fig.1. Maximum forward dissipation $P_F = f(I_{F(AV)})$ per diode; square current waveform where $I_{F(AV)} = I_{F(RMS)} \times \sqrt{D}$.

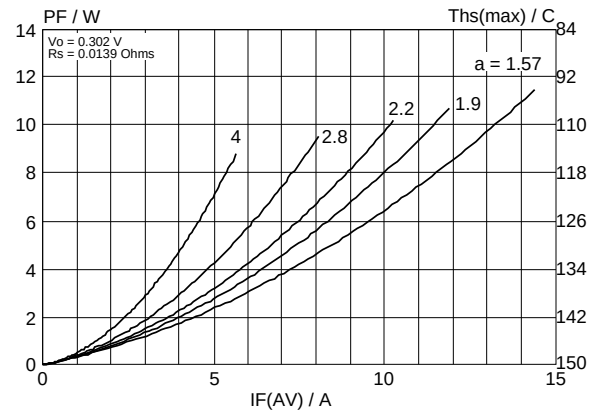


Fig.2. Maximum forward dissipation $P_F = f(I_{F(AV)})$ per diode; sinusoidal current waveform where a = form factor = $I_{F(RMS)} / I_{F(AV)}$.

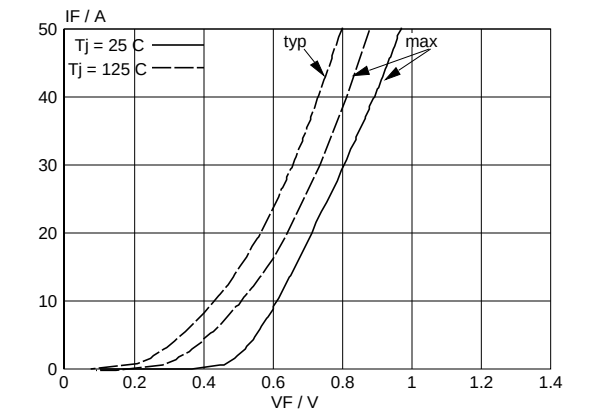


Fig.3. Typical and maximum forward characteristic $I_F = f(V_F)$; parameter T_j

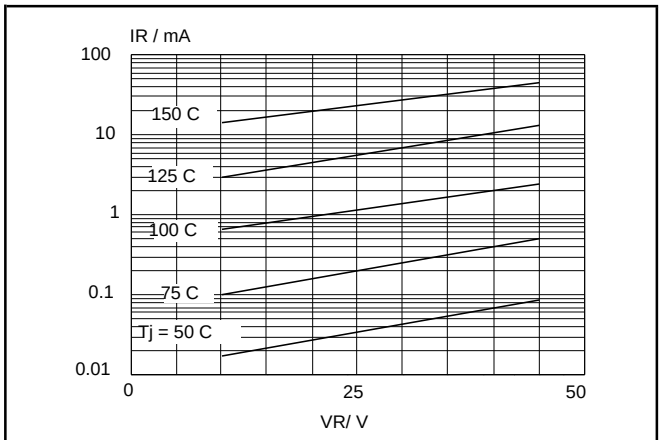


Fig.4. Typical reverse leakage current per diode; $I_R = f(V_R)$; parameter T_j

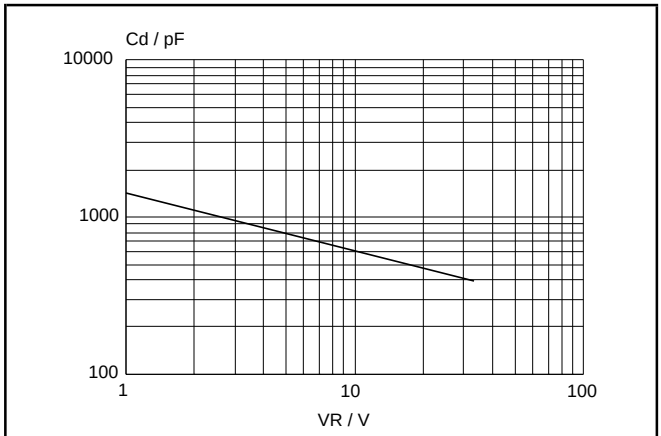


Fig.5. Typical junction capacitance per diode; $C_d = f(V_R)$; f = 1 MHz; T_j = 25˚C to 125 ˚C.

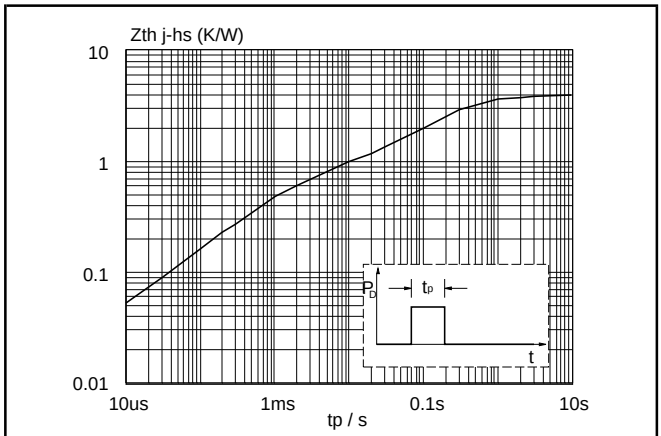


Fig.6. Transient thermal impedance per diode; $Z_{th\ j\text{-}hs} = f(t_p)$.

MECHANICAL DATA

Dimensions in mm

Net Mass: 5.5 g

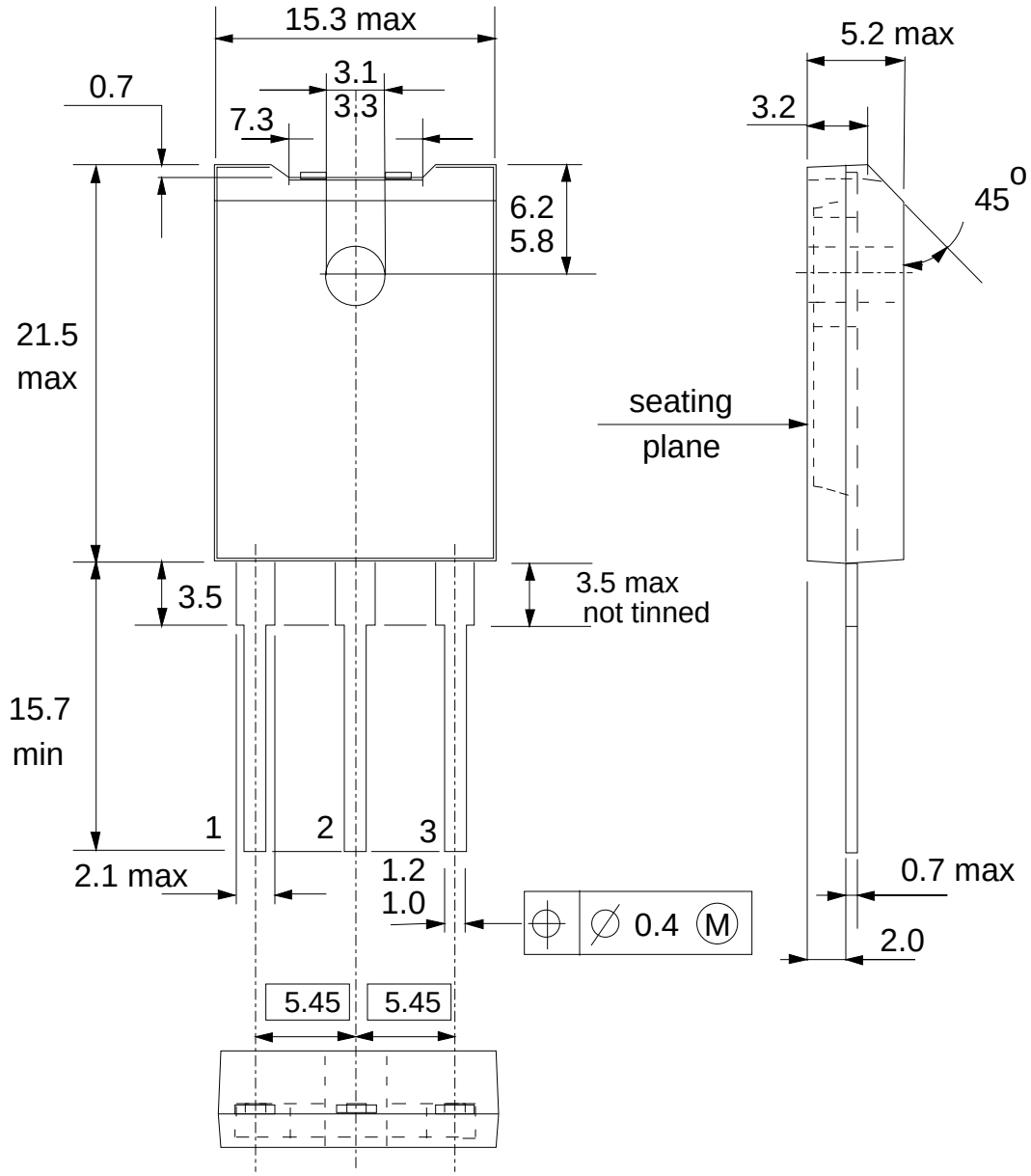


Fig.7. SOT199; The seating plane is electrically isolated from all terminals.

Notes

1. Accessories supplied on request: refer to mounting instructions for F-pack envelopes.

DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.